NSN 5962-01-384-7819



Memory Microcircuit - Page 1 of 1 View Online at https://aerobasegroup.com/nsn/5962-01-384-7819 **Body Length:** Between 11.2 millimeters and 11.7 millimeters **Body Width:** Between 11.2 millimeters and 11.7 millimeters **Body Height:** Between 1.5 millimeters and 2.5 millimeters **Maximum Power Dissipation Rating:** 1.0 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius **Storage Tempurature Range:** -65.0/+150.0 degrees celsius **Features Provided:** Programmed **Inclosure Material:** Ceramic **Inclosure Configuration:** Leadless flat pack **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Current Rating Per Characteristic:** 120.00 milliamperes forward current, nonrepetitive, peak total value minor **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 7.0 volts applied **Memory Device Type:** Prom **Terminal Type And Quantity:** 28 leadless Shelf Life: N/a **Unit Of Measure: Demilitarization:**

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